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Orderable: 001	Designed for: Public Release	Mod. Date: 9/25/2017
TID #: TID	Project Title: Envelope-Tracking Power Supply Reference Design	
Number: PMP15036	Rev: A	Sheet Title: PMP15036
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 1 of 3
Drawn By: Helen Chen	File: PMP15036_1_SchDoc	Size: B
Engineer: Helen Chen	Contact: http://www.ti.com/support	

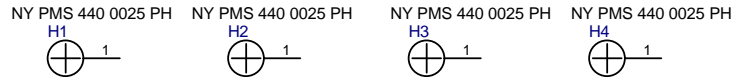


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PCB Number: PMP15036
PCB Rev: A

ZZ1

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ2

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3

Assembly Note

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Designed for: Public Release	Mod. Date: 9/23/2017
Project Title: Envelope-Tracking Power Supply Reference Design	
Sheet Title:	
Assembly Variant: 001	Sheet: 3 of 3
File: PMP15036_Hardware.SchDoc	Size: A4
Contact: http://www.ti.com/support	



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Number: [PMP15036](#) Rev: [A](#)
SVN Rev: Version control disabled
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Engineer: [Helen Chen](#)

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